Low Phase Noise Amplifier 4 - 8 GHz



MAAL-011154-DIE

Rev. V1

Features

• Phase Noise: 165 dBc/Hz @ 10 kHz

Gain: 15 dBP1dB: 20 dBm

Bias Voltage: V_{CC} = +5 V
 Bias Current: I_{CQ} = 85 mA
 50 Ω Matched Input and Output

Positive Voltage Only

Die Size: 2265 x 1695 x 100 μm

RoHS* Compliant

Applications

Radar

Electronic Countermeasures

Test and Measurement

Microwave Communication Systems

Description

The MAAL-011154-DIE is an easy to use low phase noise amplifier chip. It operates from 4 - 8 GHz and provides 165 dBc/Hz phase noise, 15 dB gain and 20 dBm P1dB. The input and output are fully matched to $50~\Omega$ with typical return loss >15 dB.

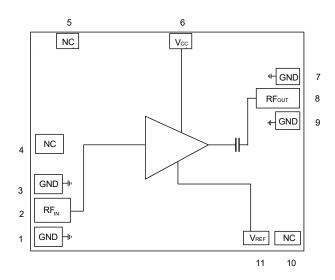
This product is fabricated using a GaAs HBT process which features full passivation for enhanced reliability.

The MAAL-011154-DIE is ideally suited for Radar, Test and Measurement, EW, ECM, and Microwave Communication Systems applications.

Ordering Information

Part Number	Package
MAAL-011154-DIE	Gel Pack

Functional Schematic



Pad Configuration¹

Pad #	Pad Name	Description	
1,3,7,9	GND	DC + RF Ground to Backside Via	
2	RF _{IN}	RF Input	
4,5,10	NC	Not Connected	
6	V _{CC}	Supply Voltage	
8	RF _{OUT}	RF Output	
11	V_{REF}	Reference Voltage	

Backside of die must be connected to RF, DC and thermal ground.

^{*} Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



Electrical Specifications:

Freq. = 4 - 8 GHz, T_A = +25°C, V_{CC} = 5 V, Z_0 = 50 Ω (Based on probed die production data)

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	P _{IN} = -15 dBm	dB	13.5	15.7	_
Gain Flatness	_	dB	_	±0.2	_
Gain Variation over Temperature	_	dB/°C	_	0.011	
Output Power	P_{IN} = +5.4 dBm, 4 GHz P_{IN} = +5.4 dBm, 6 GHz P_{IN} = +3.0 dBm, 8 GHz	dBm	18.5 18.5 16	20.5 20.5 18.	_
Noise Figure	_	dB	_	5.1	
Input Return Loss	_	dB	_	17	_
Output Return Loss	_	dB	_	16	
P1dB	6 GHz	dBm	_	20	_
P3dB	6 GHz	dBm	_	21	
OIP3	6 GHz, -10 dBm P _{IN} per tone	dBm	_	30.5	
Phase Noise	4 GHz, P1dB 100 Hz 1 kHz 10 kHz 1 MHz	dBc/Hz	_	149 160 165 175	_
Icq	_	mA	_	85	_

Absolute Maximum Ratings^{2,3}

Parameter	Absolute Maximum	
Input Power	14 dBm	
V _{CC}	6 V	
I _{CC}	105 mA	
Junction Temperature ^{4,5}	+150°C	
Operating Temperature	-40°C to +85°C	
Storage Temperature	-40°C to +150°C	

- 2. Exceeding any one or combination of these limits may cause permanent damage to this device.
- 3. MACOM does not recommend sustained operation near these survivability limits.
- 4. Operating at nominal conditions with T_J ≤ +150°C will ensure MTTF > 1×10^6 hours.
- 5. Junction Temperature $(T_J) = T_C + \Theta jc * (V * I)$ Typical thermal resistance (Θjc) = 25.9 °C/W.

a) For $T_C = +25^{\circ}C$,

 $T_J = 41.3$ °C @ 6 V, 105 mA

b) For $T_C = +85^{\circ}C$,

T_J = 101.3°C @ 6 V, 105 mA

Handling Procedures

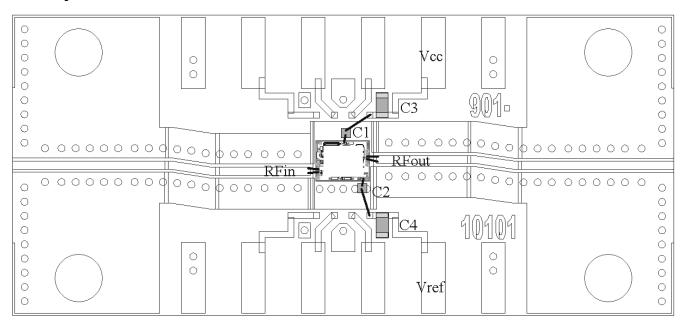
Please observe the following precautions to avoid damage:

Static Sensitivity

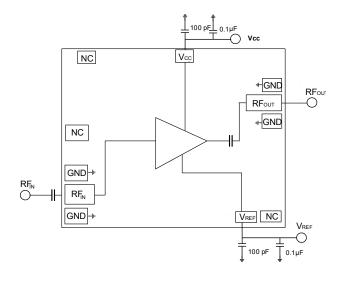
electronic devices are sensitive electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A, 250 V devices.



PCB Layout



Application Schematic



Operation

The technology is HBT; so, the turn-on and turn-off procedure is fairly simple.

To turn-on simply:

- 1. Apply +5 V to V_{CC}
- 2. Starting at 0 V, adjust V_{REF} for target I_{CC}

To turn-off:

- 1. Set V_{REF} to 0 V
- 2. Set V_{CC} to 0 V

Evaluation PCB Specifications

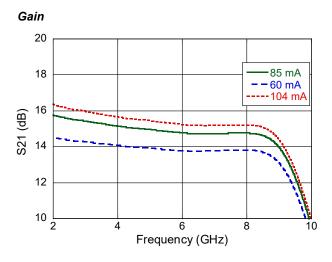
Top Layer: 1/2 oz Copper Cladding, 0.017 mm thickness Dielectric Layer: Rogers RO4003C 0.203 mm thickness Bottom Layer: 1/2 oz Copper Cladding, 0.017 mm thickness Finished overall thickness: 0.237 mm

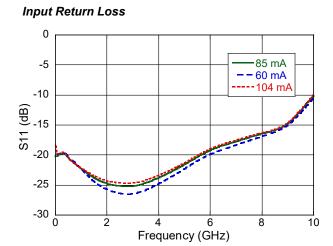
Parts List

Part	Value	Case Style	MFG	MFG Part #
C1, C2	100 pF	Single Layer	MACOM	MC2S100025-025
C3, C4	0.1 μF	0402	KYOCERA	04023C103KAT2A

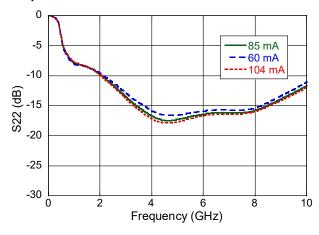


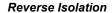
Typical Performance Curves: V_{CC} = 5 V, +25°C

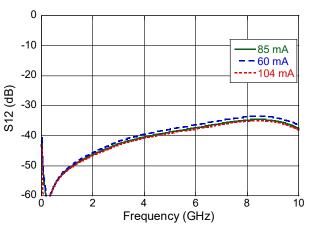


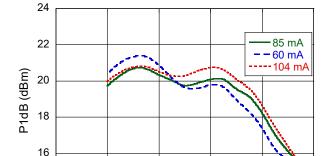


Output Return Loss

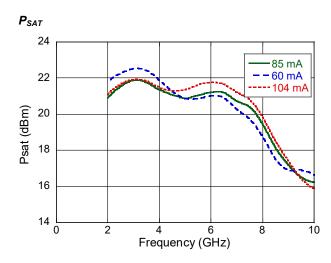








4 6 Frequency (GHz) 8



4

P1dB

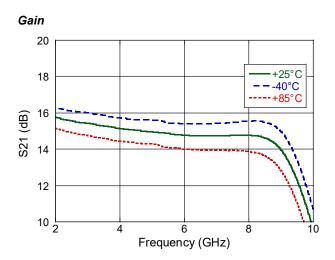
14

10

2



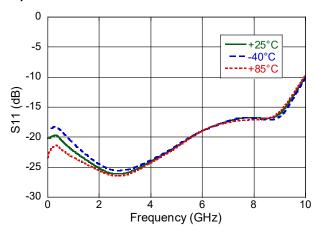
Typical Performance Curves: $V_{CC} = 5 V$, $I_{CC} = 85 mA$



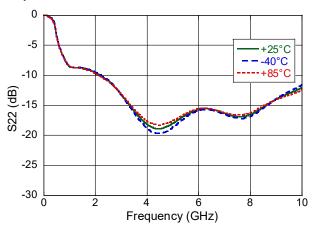
Noise Figure 12 10 8 8 6 4 2 0 2 4 6 8 10

Frequency (GHz)

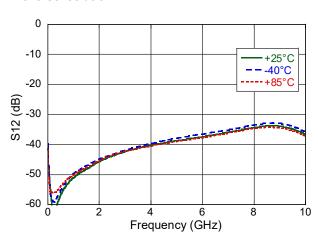
Input Return Loss



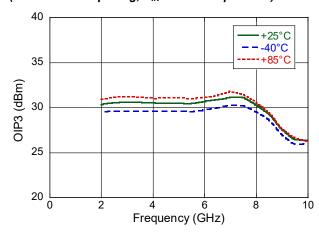
Output Return Loss



Reverse Isolation

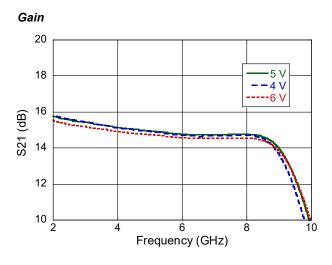


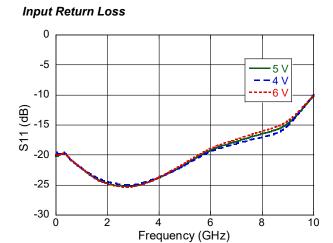
Output IP3 (10 MHz Tone Spacing, $P_{IN} = -10$ dBm per tone)



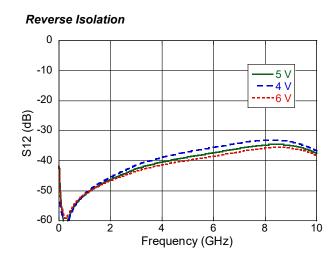


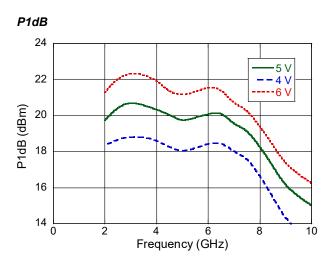
Typical Performance Curves: I_{CC} = 85 mA, +25°C

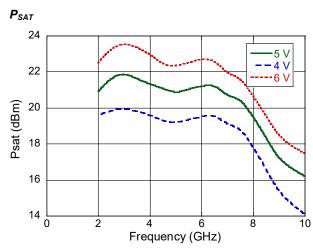




Output Return Loss 0 -5 -10 -10 -10 -25 -30 0 2 4 6 8 10 Frequency (GHz)









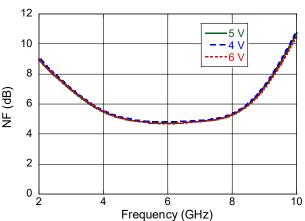
Typical Performance Curves: +25°C

Noise Figure @ 5 V

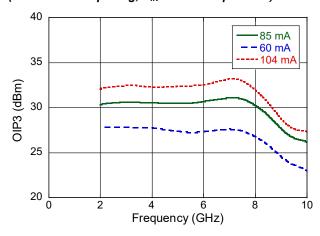
12
10
85 mA
--60 mA
--00 mA
--104 mA

2
0
2
4
6
8
8
10
Frequency (GHz)

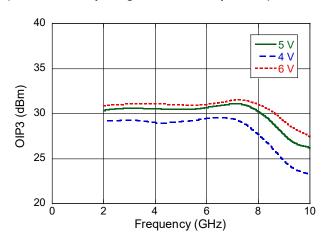
Noise Figure @ 85 mA



Output IP3 @ 5 V (10 MHz Tone Spacing, $P_{IN} = -10$ dBm per tone)



Output IP3 @ 85 mA (10 MHz Tone Spacing, $P_{IN} = -10$ dBm per tone)





Typical Performance Curves: I_{CC} = 85 mA, +25°C

10000

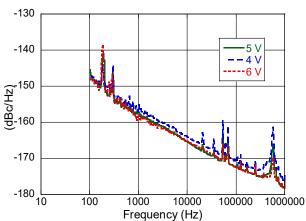
Frequency (Hz)

100000

1000000

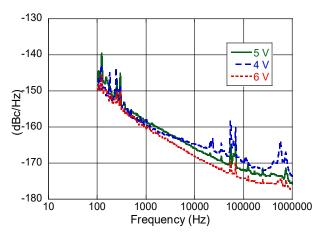
Phase Noise @ 4 GHz, P1dB -130 5 V -140 · 4 V ---6 V (dBc/Hz) 160 -170 -180 L 10

Phase Noise @ 4 GHz, P4dB

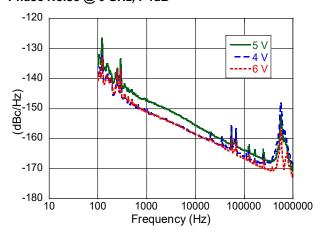


Phase Noise @ 6 GHz, P1dB

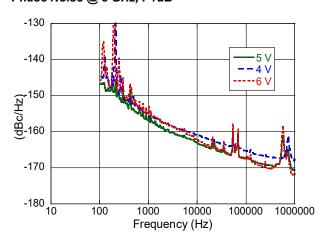
100



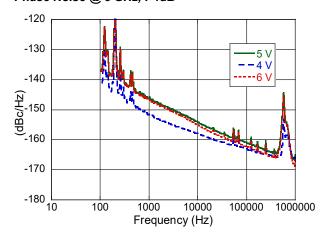
Phase Noise @ 6 GHz, P4dB



Phase Noise @ 8 GHz, P1dB

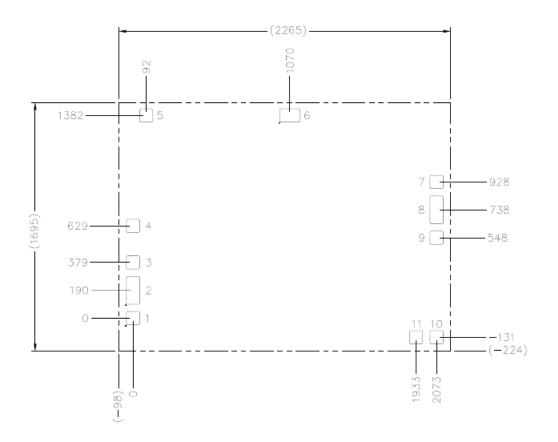


Phase Noise @ 8 GHz, P4dB





MMIC Die Outline



Bond Pad Detail^{6,7,8,9}

Pad #	x	Y
1,3,4,5,7,9,10,11	100	100
2,8	100	200
6	140	100

- 6. All dimensions shown as microns (μm) with a tolerance of +/-5 μm , unless otherwise noted.
- 7. Die thickness is $100 \, \mu \text{m}$ +/- $10 \, \mu \text{m}$.
- 8. Bond pad and backside metalization: gold
- Die size reflects cut dimensions. Saw or laser kerf reduces die size by ~ 25 µm each dimension.

Low Phase Noise Amplifier 4 - 8 GHz



MAAL-011154-DIE

Rev. V1

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